جامعة بنها - كلية الهندسة ببنها - قسم الهندسة الكهربية

الإجابة النموذجية لمادة الكترونيات القوى ك 591 تخلفات الثلاثاء الموافق ٢٠١٦/١/١٩

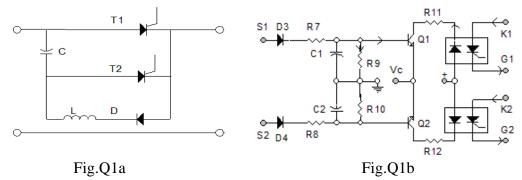
Benha University	Time: 3hour		- Juliu
Benha Faculty of Engineering	Forth Year		
Subject: Power Electronics (E591)	Elect. Eng. Dept.	And the second with the	A Departure

Answer only four questions and explain by drawing any where you can.

Question-1

(15 marks)

Q1a. Explain the operation of the dc chopper circuit shown in Fig.Q1a. Suggest a suitable firing scheme for such circuit. Explain, haw the firing pulses are generated and directed to each Thyristor. Make changes for safety operation with inductive load.



Q1b. Figure Q1b shows a simplified firing circuit which may be used to drive a single phase D.C. converter. It has some disadvantages, which? Explain the operation of this circuit, and what do you suggest to overcome its disadvantages? Remember that, S1 and S2 are Square waves.

Question-2

(15 marks)

- Q2a. Figure Q2a shows one of the techniques for power factor correction for three-phase controlled rectifiers. Explain the principle of operation of this scheme and mention its advantages and disadvantages.
- Q2b. The converter of Figure Q2b can operate in two modes: as DC Chopper to drive a dc load, or as Single Phase Inverter to drive ac single-phase load. Explain sequence of operation for each mode of operations?

Suggest a suitable firing circuit for the given converter for one mode of operation.

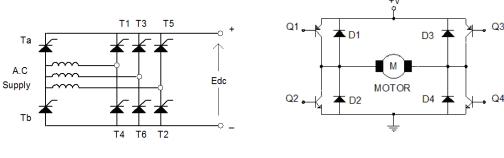


Fig.Q2a



P.T.O.

Question-3

(15 marks)

Q3a. Draw any two Inverter power circuits you know (not given) and explain how do they work? What is a natural and forced commutation? What is the meaning of load commutation, constant current source inverter and constant voltage source inverter?

O3b.	Suggest a	suitable	firing	circuit	for one	Inverter	circuit in	O3a.
C	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~		0					C

Question-4

(15 marks)

a- Write short notes about:

i-power diode ii-transistor iii-thyristor iv- GTO thyristor

- b- Write the main parts of a power electronic system?
- c- How to protect the transistor against over:

i-current ii- voltage iii-temperature degree iv- di/dt v-dv/dt

Question-5

(15 marks)

a-Define: latch current- hold current?

- b-A power electronic circuit consists of DC power supply (200V), thyristor (latching current level 10 mA) and inductive load(40Ω , 1H) neglect the thyristor voltage drop.
- i- Draw the power circuit?

ii- Show that the thyristor will fail to remain on when the firing pulse ends after 25µsec.?

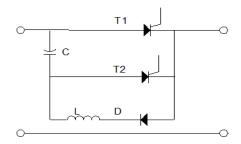
- iii- Find the minimum pulse length of the correct firing pulse?
- iv- Find the maximum value of shunt resistance (to load) to ensure firing using pulse of length 25µsec.

v- Show how to turn off the thyristor?

Model answer

Question-1

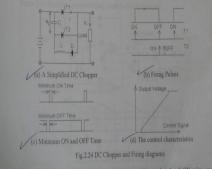
Q1a. Explain the operation of the dc chopper circuit shown in Fig.Q1a. Suggest a suitable firing scheme for such circuit. Explain, haw the firing pulses are generated and directed to each Thyristor. Make changes for safety operation with inductive load.



(c) Minimum ON and OFF Time

1/1]- Thyristor-Chopper

(c) Introduce competer Most DC chapters will have at least two thyristors, one main power carrying thyristor T1 and one auxiliarly whitrike T2 used to turn the main one off. The main thyristor will be operated with a mark space arrangement at an appropriately chosen frequency which may or may not vary. It will normally be fired for the whole of the conduction period to allow current to flow at all times. The gate pulse on the main thyristor will usually be removed at the same time as the turn-off thyristor is fired. The turn-off thyriston romally only have a gate pulse of relatively short length applied to it. Figure 2.24 illustrates the firing pattern and also shows other features of these systems.



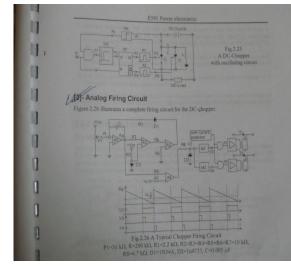
The needs of the commutation process require a minimum length of ON-pulse and a minimum OFF-period to ensure the correct charging of the commutation capacitors. These back and front limits could be applied by restricting the range of the mark space control signal, but this may prevent the unit from being used with zero output or will full conduction, both of which are desirable operating conditions. If the limits are applied after the mark space control agramements, this true extreme operating conditions can then be used and there will be the state of the state of the state of the limits are applied after the mark space control agramements, this true extreme operating conditions can then be used and there will be the state of th control arrangements, this two extreme operating conditions can then be used and there will be a small step in the control characteristics at each end of the control range. This characteristic shows what would be achieved by a linear or triangular wave to generate the mark space control.

Fig.2.24 DC Chopper and Firing diagrams

(d) The control characteristics

Figure 2.25 shows a dc chopper with oscillating circuit. The circuit functions as follows;

- 1. The firing pulse P is generated using any firing circuit.
- The initig puse is generated using any imagerout.
 The AND gate can transfer this pulse P only when the voltage across the main thyristor T1 is positive and the sensing unit M1 gives a high output as a control signal Pe.
 The output of the AND gate P1 is delayed by unit M2 which gives the pulse P2 to set the FlipFlop FF to deliver the two signals P3 and P4.
 Each of these signals is amplified through the two units A1 and A2 then transferred as P5 and P6 to the corresponding theritor.
- and P6 to the corresponding thyristor.



Vat						
t-	1					
P1=50 kO R-20	2.20 A Typ	ical Chopper	Firing	Circui	t (-D.7-1	0.10
P1=50 kΩ, R=20 R8=4.7 it functions as follo	K12, D1=1N	34A, D2=1n	G=R4=	C=0.00	0=R/=))5 μF	10 KSZ,

This cit

- The three operational amplifiers A1, A2 and A3 together form a triangular wave generator that generates the signal e_b.
 As e_a decreases below the forward bias voltage of the diode D2, the output of A2 changes from about V_{ec} to about -V_{ec} which in turn triggers A3 to change state.
 The output of A3, which is now about -V_{ec} makes D1 forward biased, and the R1-D1 path takes control of the integrator input summing junction.
 The output of A1 quickly rises to about V_{ec} which in turn triggers A2 and A3 and

- The output of A1 quickly rises to about V_{ec} which in turn triggers A2 and A3 and changes their outputs to positive voltages.
 The diode D1 is now reverses biased and the feedback loop through D1 is open.
 The control of integrator A1 reverts to the R path and the output voltage e, has a constant slope that depends on the values of the capacitor, C, the input resistor R, and the input voltage e.

- The comparator A4 compares the signal ea with the control voltage Vc and gives the pulse signal V2.

36

E591 Power electronics

- E591 Power electronics The two monostables M1 and M2 are connected in such a way that one of them is triggered by the rising edge and the other by the falling edge of the signal V2, producing V3 and V4 respectively whose width can be adjusted. A pulse width in the range of 200 pulse is sufficient for firing SCRs. The pulse V3 for the main SCR T1 can be "ANDED: with a signal from an over current protection logic circuit so than when an over-current condition occurs, the firing pulse is blocked. The firing pulses P1 and P2 are fed to the pulse amplifier circuits consisting of a Darlington transistor and a pulse transformer.

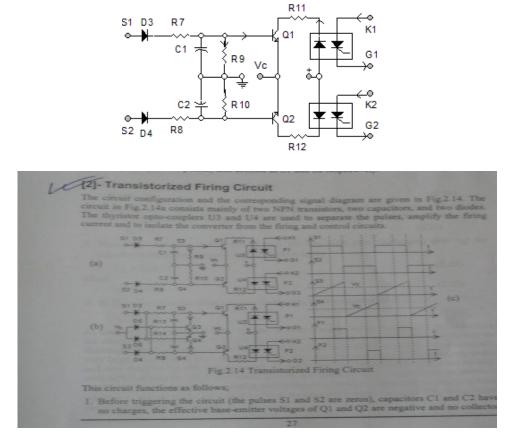
The purpose of using A2 is to introduce a time delay so that there is enough time to charge up the capacitor so that e_a rises to about V_{ee} . The diode D2 used for the offset adjustment so that e_a is always above zero.

2.2.6 Controlled Inverter

[1]- Block Diagram

Most inverter applications require some means of controlling AC output voltage. Figure 2.27 shows the general block diagram of such inverter and its drive circuit. Here the

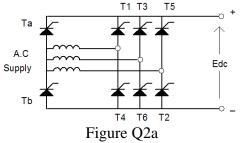
Q1b. Figure Q1b shows a simplified firing circuit which may be used to drive a single phase D.C. converter. It has some disadvantages, which? Explain the operation of this circuit, and what do you suggest to overcome its disadvantages? Remember that, S1 and S2 are Square waves.

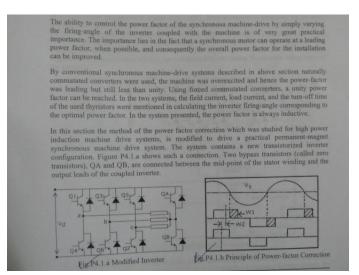


Question-2

(15 marks)

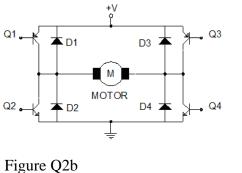
Q2a. Figure Q2a shows one of the techniques for power factor correction for three-phase controlled rectifiers. Explain the principle of operation of this scheme and mention its advantages and disadvantages.

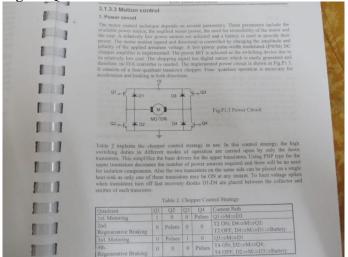




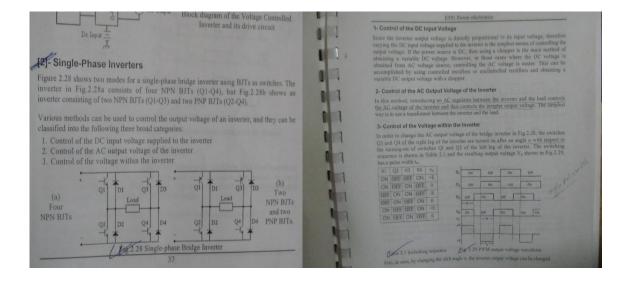
Q2b. The converter of Figure Q2b can operate in two modes: as DC Chopper to drive a dc load, or as Single Phase Inverter to drive ac single-phase load. Explain sequence of operation for each mode of operations?

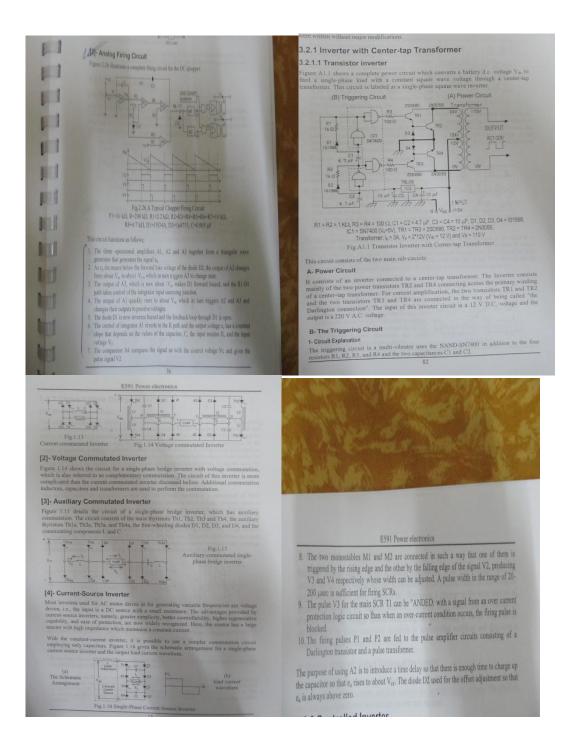
Suggest a suitable firing circuit for the given converter for one mode of operation.

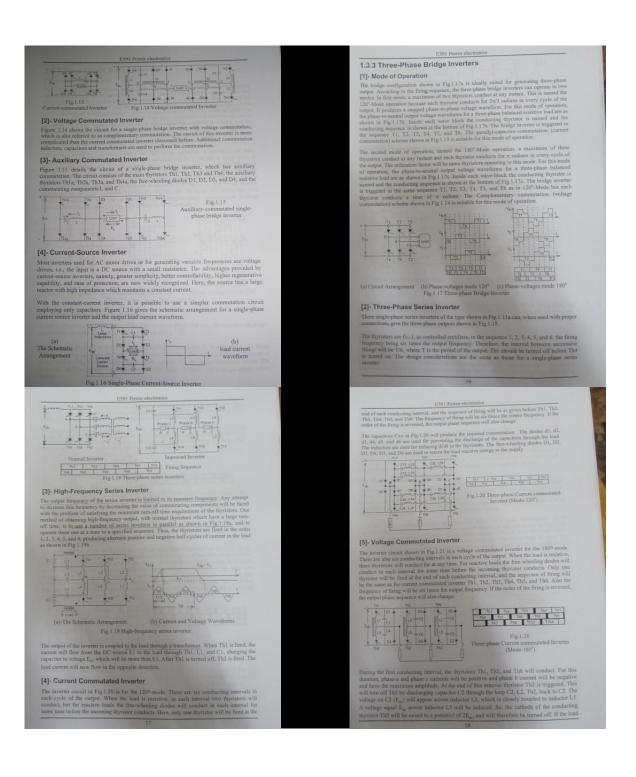


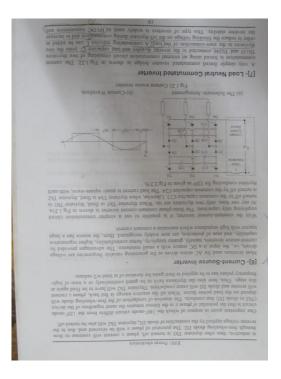


Q3a. Draw any two Inverter power circuits you know (not given) and explain how do they work? What is a natural and forced commutation? What is the meaning of load commutation, constant current source inverter and constant voltage source inverter?









Q3b. Suggest a suitable firing circuit for one Inverter circuit in Q3a.

(15 marks)

<u>Question-4</u> a- Write short notes about: i-power diode ii-transistor iii-thyristor iv- GTO thyristor

2.3 Common Diode Types

Depending on their applications, diodes can be segregated into the following major divisions:

Small Signal Diode. These are the semiconductor devices used most often in a wide variety of applications. In general purpose applications, they are used as a switch in rectifiers, limiters, capacitors, and in wave shaping. The common diode parameters a designer needs to know include forward voltage, reverse breakdown voltage, reverse leakage current, and recovery time. Silicon Rectifier Diode. These are the diodes that have high forward-current carrying capability, typically up to several hundred amperes. They usually have a forward resistance of only a fraction of an ohm while their reverse resistance is in the megaohm range. Their primary application is in power conversion, such as for power supplies, UPS, rectifiers/inverinverters etc. In case of current exceeding the rated value, their case temperature will rise. For stud mounted diodes, their thermal resistance is between 0.1 to 1° C/W.

Zener Diode. Its primary applications are in the voltage reference or regulation. However, its ability to maintain a certain voltage depends on its temperature coefficient and impedance. The voltage reference or regulation application of Zener diodes are based on their avalanche properties. In the reverse-biased mode, at a certain voltage the resistance of these devices may suddenly drop. This occurs at the Zener voltage V_X , a parameter the designer knows beforehand.

Photodiode. When a semiconductor junction is exposed to light, photons generate hole-electron pairs. When these charges diffuse across the junction, they produce photo current. Hence this device acts as a source of current that increases with the intensity of light.

Light-Emitting Diode (LED). Power diodes used in PE circuits are high-power versions of the commonly used devices employed in analog and digital circuits. They are manufactured in many varieties and ranges. The current rating can be from a few amperes to several hundreds while the voltage rating varies from tens of volts to several thousand volts.

1.2 Diodes

Sohail Anwar

Power diodes play an important role in power electronics circuits. They are mainly used as uncontrolled rectifiers to convert single-phase or three-phase AC voltage to DC. They are also used to provide a path for the current flow in inductive loads. Typical types of semiconductor materials used to construct diodes are silicon and germanium. Power diodes are usually constructed using silicon because silicon diodes can operate at higher current and at higher junction temperatures than germanium diodes. The symbol for a semiconductor diode is given in Fig. 1.9. The terminal voltage and current are represented as V_d and I_{db} respectively. Figure 1.10 shows the structure of a diode. It has an anode (A) terminal and a cathode (K) terminal. The diode is constructed by joining together two pieces of semiconductor material—a *p*-type and an *n*-type—to form a *pn*-junction. When the anode terminal is positive with respect to the cathode

Characteristics

The voltage-current characteristics of a diode are shown in Fig. 1.11. In the forward region, the diode starts conducting as the anode voltage is increased with respect to the cathode. The voltage where the current starts to increase rapidly is called the knee voltage of the diode. For a silicon diode, the knee voltage is approximately 0.7 V. Above the knee voltage, small increases in the diode voltage produce large increases in the diode current. If the diode current is too large, excessive heat will be generated, which can destroy the diode. When the diode is reverse-biased, diode current is very small for all values of reverse voltage less than the diode breakdown voltage. At breakdown, the diode current increases rapidly for small increases in diode voltage.

Principal Ratings for Diodes

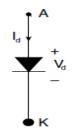
Figures 1.12 and 1.13 show typical data sheets for power diodes.

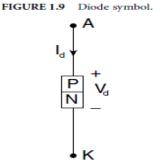
Maximum Average Forward Current

The maximum average forward current $(I_{f(avg)max})$ is the current a diode can safely handle when forward biased. Power diodes are available in ratings from a few amperes to several hundred amperes. For example, the power diode D_6 described in the data specification sheet (Fig 1.12) can handle up to 6 A in the forward direction when used as a rectifier.

Peak Inverse Voltage

The peak inverse voltage (PIV) of a diode is the maximum reverse voltage that can be connected across a diode without breakdown. The peak inverse voltage is also called peak reverse voltage or reverse breakdown voltage. The PIV ratings of power diodes extend from a few volts to several thousand volts. For example, the power diode D_6 has a PIV rating of up to 1600 V, as shown in Fig. 1.12.







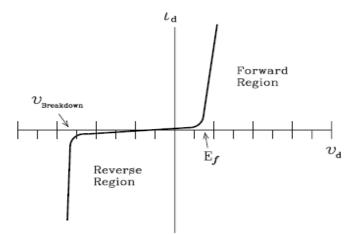


FIGURE 1.11 Diode voltage-current characteristic.

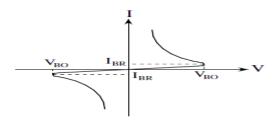


FIGURE 1.25 The DIAC characteristics.

Thyristor and Triac

The thyristor, also called a silicon-controlled rectifier (SCR), is basically a four-layer three-junction *pnpn* device. It has three terminals: anode, cathode, and gate. The device is turned on by applying a short pulse across the gate and cathode. Once the device turns on, the gate loses its control to turn off the device. The turn-off is achieved by applying a reverse voltage across the anode and cathode. The thyristor symbol and its volt–ampere characteristics are shown in Fig. 1.1. There are basically two classifications of thyristors: converter grade and inverter grade. The difference between a converter-grade and an inverter-

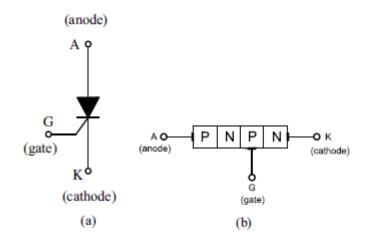


FIGURE 1.21 (a) The SCR symbol; (b) the SCR structure.

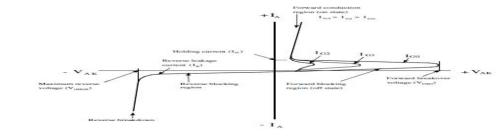


FIGURE 1.22 SCR characteristics.

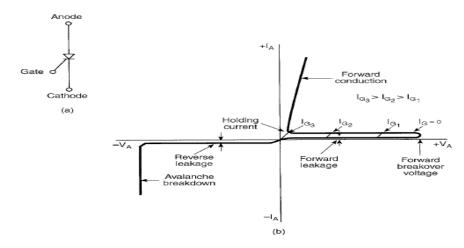


FIGURE 1.1 (a) Thyristor symbol and (b) volt–ampere characteristics. (From Bose, B.K., Modern Power Electronics: Evaluation, Technology, and Applications, p. 5. © 1992 IEEE. With permission.)

Gate Turn-Off Thyristor

The GTO is a power switching device that can be turned on by a short pulse of gate current and turned off by a reverse gate pulse. This reverse gate current amplitude is dependent on the anode current to be turned off. Hence there is no need for an external commutation circuit to turn it off. Because turn-off is provided by bypassing carriers directly to the gate circuit, its turn-off time is short, thus giving it more capability for high-frequency operation than thyristors. The GTO symbol and turn-off characteristics are shown in Fig. 1.3.

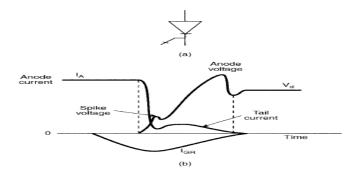


FIGURE 1.3 (a) GTO symbol and (b) turn-off characteristics. (From Bose, B.K., Modern Power Electronics: Evaluation, Technology, and Applications, p. 5. © 1992 IEEE. With permission.)

The Gate Turn-Off Thyristor

The GTO is a power semiconductor switch that turns ON by a positive gate signal. It can be turned OFF by a negative gate signal. The GTO symbol is shown in Fig. 1.29a and the GTO structure is shown in Fig. 1.29b. The GTO voltage and current ratings are lower than those of SCRs. The GTO turn-off time is lower than that of SCR. The turn-on time is the same as that of an SCR.

A GTO can operate safely in the "reverse avalanche" region for a short time provided the gate .cathode junction is reverse biased

The switching delay times and energy loss of a GTO can be reduced by increasing the gate • .current magnitude and its rate of rise

The maximum turn off anode current of a GTO can be increased by increasing the turn off • snubber capacitance

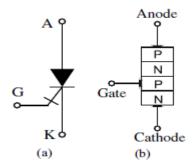


FIGURE 1.29 (a) The GTO symbol; (b) the GTO structure.

1.5 Power Bipolar Junction Transistors

Sohail Anwar

Power bipolar junction transistors (BJTs) play a vital role in power circuits. Like most other power devices, power transistors are generally constructed using silicon. The use of silicon allows operation of a BJT at higher currents and junction temperatures, which leads to the use of power transistors in AC applications where ranges of up to several hundred kilowatts are essential.

The power transistor is part of a family of three-layer devices. The three layers or terminals of a transistor are the base, the collector, and the emitter. Effectively, the transistor is equivalent to having two *pn*-diode junctions stacked in opposite directions to each other. The two types of a transistor are termed *npn* and *pnp*. The *npn*-type transistor has a higher current-to-voltage rating than the *pnp* and is preferred for most power conversion applications. The easiest way to distinguish an *npn*-type transistor from a *pnp*-type is by virtue of the schematic or circuit symbol. The *pnp* type has an arrowhead on the emitter that points toward the base. Figure 1.36 shows the structure and the symbol of a *pnp*-type transistor. The *npn*-type transistor has an arrowhead pointing away from the base. Figure 1.37 shows the structure and the symbol of an *npn*-type transistor.

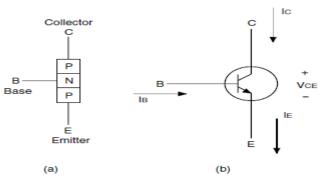


FIGURE 1.36 pnp transistor structure (a) and circuit symbol (b).

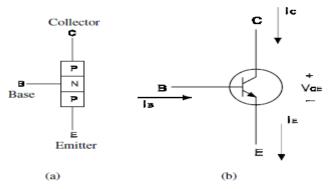


FIGURE 1.37 npn transistor structure (a) and circuit symbol (b).

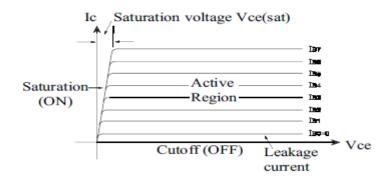
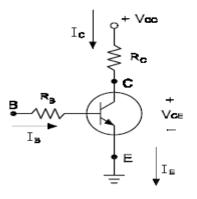
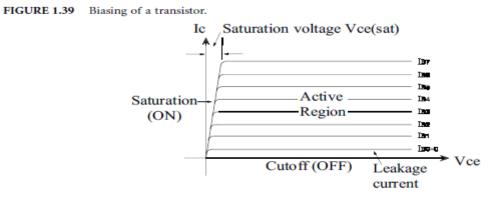
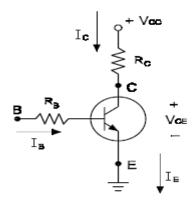


FIGURE 1.38 BJT V-I characteristic.











Power Transistor

Power transistors are used in applications ranging from a few to several hundred kilowatts and switching frequencies up to about 10 kHz. Power transistors used in power conversion applications are generally *npn* type. The power transistor is turned on by supplying sufficient base current, and this base drive has to be maintained throughout its conduction period. It is turned off by removing the base drive and making the base voltage slightly negative (within $-V_{BE(max)}$). The saturation voltage of the device is normally 0.5 to 2.5 V and increases as the current increases. Hence, the on-state losses increase more than proportionately with current. The transistor off-state losses are much lower than the on-state losses because the leakage current of the device is of the order of a few milliamperes. Because of relatively larger switching times, the switching loss significantly increases with switching frequency. Power transistors can block only forward voltages. The reverse peak voltage rating of these devices is as low as 5 to 10 V.

Power transistors do not have I^2t withstand capability. In other words, they can absorb only very little energy before breakdown. Therefore, they cannot be protected by semiconductor fuses, and thus an electronic protection method has to be used.

Power MOSFET

Power MOSFETs are marketed by different manufacturers with differences in internal geometry and with different names such as MegaMOS, HEXFET, SIPMOS, and TMOS. They have unique features that make them potentially attractive for switching applications. They are essentially voltage-driven rather than current-driven devices, unlike bipolar transistors.

The gate of a MOSFET is isolated electrically from the source by a layer of silicon oxide. The gate draws only a minute leakage current on the order of nanoamperes. Hence, the gate drive circuit is simple and power loss in the gate control circuit is practically negligible. Although in steady state the gate draws virtually no current, this is not so under transient conditions. The gate-to-source and gate-to-drain

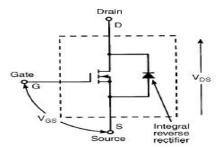
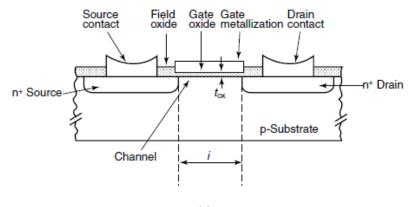


FIGURE 1.5 Power MOSFET circuit symbol. (From Bose, B.K., Modern Power Electronics: Evaluation, Technology, and Applications, p. 7. © 1992 IEEE. With permission.)

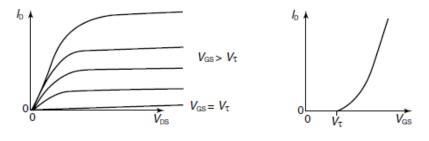
1.6 MOSFETs

Vrej Barkhordarian

The metal-oxide-semiconductor field-effect transistor (MOSFET) is the most commonly used active device in very large scale integrated (VLSI) circuits. Figure 1.54 shows the device schematic, current-voltage characteristics, transfer characteristics and device symbol for a MOSFET. It is a lateral device and though very suitable for integration into integrated circuits, it has severe limitations at high power levels. The power MOSFET design is based on the original field-effect transistor and, since its invention in the early 1970s, has gone through several evolutionary steps. The processing of power MOSFETs is very similar to that of today's VLSI circuits although the device geometry is significantly different from the











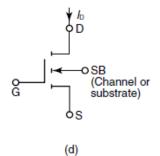


FIGURE 1.54 (a) Schematic diagram, (b) current-voltage characteristics, (c) transfer characteristics, and (d) device symbol for an *n*-channel enhancement mode MOSFET.

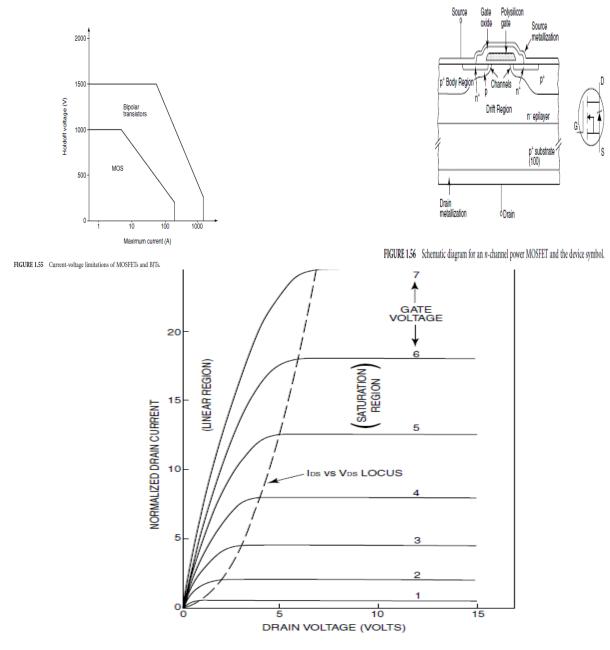


FIGURE 1.59 Current-voltage characteristics of a power MOSFET. Insulated-Gate Bipolar Transistor (IGBT)

The IGBT has the high input impedance and high-speed characteristics of a MOSFET with the conductivity characteristic (low saturation voltage) of a bipolar transistor. The IGBT is turned on by applying a positive voltage between the gate and emitter and, as in the MOSFET, it is turned off by making the gate signal zero or slightly negative. The IGBT has a much lower voltage drop than a MOSFET of similar ratings.

b- Write the main parts of a power electronic system?•

1-Isolated power supplies	2-main power circ uit	3-protection circuit
4-control circuit	5-drive circuit	6-commutation circuit

c- How to protect the transistor against:

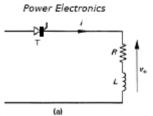
i- over current	Using series fast fuse or circuit breaker
ii- over voltage	Using varestor or selenium diode
iii- over temperature degree	Using heat sinks with fins
iv- over di/dt	Using series inductances
v- over dv/dt	Using snubber circuit RCD

Question-5

(15 marks)

a-Define: latch current is the minimum anode current after which the thyristor changes to on state from off state unless removing the gate pulse

- hold current is the minimum anode current after which the thyristor changes to off state from on state.
- b-A power electronic circuit consists of DC power supply (200V), thyristor (latching current level 10 mA) and inductive load(40Ω , 1H) neglect the thyristor voltage drop.



- i- Draw the power circuit
- ii- Show that the thyristor will fail to remain on when the firing pulse ends after

25µsec.?
$$i_l = \frac{v}{R} \left(1 - e^{-\frac{Rt}{L}} \right) = \frac{200}{40} \left(1 - e^{-\frac{40 \times 25 \times 10^{-6}}{1}} \right) = 5mA$$

iii- Find the minimum pulse length of the correct firing pulse?

$$i_{l} = \frac{V}{R} \left(1 - e^{-\frac{Rt}{L}} \right) = \frac{200}{40} \left(1 - e^{-\frac{40 * t}{1}} \right) = 10 \text{ mA, then } t = 50 \mu \text{sec}$$

iv- Find the maximum value of shunt resistance (to load) to ensure firing using pulse of length 25µsec.

$$R = \frac{V}{I} = \frac{200}{10mA - 5mA} = \frac{200}{5mA}$$
, R=40KΩ

v- Show how to turn off the thyristor?

Connect a positive of DC power supply of 200V to a cathode of the thyristor